

PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

January 7, 2002

Applicants: Hiromichi INAGAKI et al
For: PACKAGING MATERIAL AND PACKAGED PRODUCT
Serial No.: 10/009 205 Group: Unknown
Filed: December 4, 2001 Examiner: Unknown
International Application No.: PCT/JP01/03563
International Filing Date: April 25, 2001
Atty. Docket No.: Komatsu Case 261

Assistant Commissioner for Patents
Washington, DC 20231

SECOND AMENDMENT BEFORE FIRST OFFICE ACTION

Sir:

Prior to issuance of the first Office Action in the above-identified application, kindly enter the following:

IN THE CLAIMS

Please amend Claims 1-5 as follows. A marked-up copy is also enclosed herewith.

1. (Amended) A packaging material using a film laminate in which a heat sealing agent with a low melting point is applied to a prescribed zone of an oriented film made of a synthetic resin, a cutting line is cut in the oriented film in the form of a solid or broken line passing through the zone coated with the heat sealing agent, and a cast film made of a synthetic resin and having heat sealing properties is affixed to the oriented film.

2. (Amended) A packaging material using a film laminate in which a release agent is applied to a prescribed zone of an oriented film made of a synthetic resin, a cutting line is cut in the oriented film in the form of a solid or